

**Amendments to the Claims:**

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Currently Amended) A method of manufacturing a ceramic film, comprising:  
providing a treatment target in which a raw material body including a complex oxide is applied to a substrate;~~and~~

holding the treatment target in a chamber,

supplying a gas which includes at least an oxidizing gas to the chamber, the oxidizing gas being heated to a first temperature in advance; and

crystallizing the raw material body by increasing pressure of the gas in the chamber to a predetermined pressure of two atmospheres or more and heating the treatment target to a second temperature in the chamber by a heat treatment ~~holding the treatment target in a chamber and subjecting the treatment target to a heat treatment at a predetermined pressure in a gas which is pressurized at two atmospheres or more and includes at least an oxidizing gas,~~  
wherein a capacity of the chamber is 100 times or less of a volume of the substrate,  
~~and wherein the gas is supplied to the chamber after being heated to a predetermined temperature in advance.~~

wherein the treatment target heated by a heating mechanism is provided under or on the chamber.

2. (Original) The method of manufacturing a ceramic film as defined in claim 1, wherein the heat treatment is performed by using a rapid thermal annealing method.

3. (Canceled)

4. (Currently Amended) The method of manufacturing a ceramic film as defined in claim 1, wherein the treatment target is heated to the second ~~predetermined~~ temperature at a temperature rise rate of 50°C/sec or more.

5. (Original) The method of manufacturing a ceramic film as defined in claim 1, wherein pressure of the gas in the chamber is increased to the predetermined pressure of two atmospheres or more within 60 seconds.

6. (Currently Amended) The method of manufacturing a ceramic film as defined in claim 1, wherein the gas is supplied to the chamber after being heated in advance to the first predetermined temperature of 200°C or less.

7. (Original) A pressure heat treatment device which rapidly heats a treatment target by supplying a gas including at least an oxidizing gas to a chamber, the pressure heat treatment device comprising:

the chamber;

a holder which holds the treatment target in the chamber;

a gas supply mechanism which raises a temperature of the gas to a predetermined temperature in advance and supplies the gas to the chamber;

a pressure adjustment mechanism which maintains pressure of the gas in the chamber at a predetermined pressure of two atmospheres or more; and

a heating mechanism which heats the treatment target held by the holder.

8. (Original) The pressure heat treatment device as defined in claim 7, wherein a capacity of the chamber is 100 times or less of a volume of a substrate.

9. (New) The method of manufacturing a ceramic film as defined in claim 1, wherein the capacity of the chamber is 10 times to 50 times of a volume of the treatment target.